

## MISCHQDD1000000

MSA and TAA 400GBase QSFP-DD Loopback Transceiver with 0dB Attenuation, -40 to 85C

## **Product Description**

This MSA compliant QSFP-DD loopback provides a simple solution to loopback testing on individual ports with the use of a cable assembly. It has 0dB of attenuation and is compatible with existing 400G QSFP-DD ports. All of our transceivers are built to comply with Multi-Source Agreement (MSA) standards and are uniquely serialized and tested for data-traffic and application to ensure seamless network integration. This transceiver is Trade Agreements Act (TAA) compliant. We stand behind the quality of our products and proudly offer a limited lifetime warranty.

Skylane's transceivers are RoHS compliant and lead-free.

#### **Features:**

- SFF-8024 Compliance
- Built-in surge current mitigation technology
- Built-in programmable power dissipation up to 7W
- Industrial temperature: -40 to 85 Celsius
- +3.3V power supply
- Supports 8\*10G/25G/56G PAM4 data rates
- 2-wire interface for integrated Digital Diagnostic Monitoring
- Compliant with IEEE 802.3ba, 802.3bj, and 802.3cd standards
- Enhanced heat dissipation technology for high power testing
- A multi-color LED indicator for high/low power modes
- Hot Pluggable
- RoHS Compliant and Lead-Free

#### **Applications:**

- QSFP-DD port/system testing
- Ethernet IEEE 802.3 (Gigabit, 10 Gigabit and 25 Gigabit Ethernet)
- SONET, SDH, GBE, Fiber Channel Support



For your product safety, please read the following information carefully before any manipulation of the transceiver:



#### ESC

This transceiver is specified as ESD threshold 1kV for SFI pins and 2kV for all others electrical input pins, tested per MIL-STD-883G, Method 3015.4 /JESD22-A114-A (HBM). However, normal ESD precautions are still required during the handling of this module.



## LASER SAFETY

This is a Class1 Laser Product according to IEC 60825-1:2007. This product complies with 21 CFR 1040.10 and 1040.11 except for deviations pursuant to Laser Notice No. 50, dated (June 24, 2007).

The optical ports of the module need to be terminated with an optical connector or with a dust plug in order to avoid contamination.

**Absolute Maximum Ratings** 

Parameter	Symbol	Min.	Тур.	Max.	Unit	Notes
Maximum Supply Voltage	Vcc	2.97	3.3	+3.63	V	
Storage Temperature	Tstg	-40		+85	°C	
Operating Case Temperature	Тс	-40		+85	°C	
Storage Relative Humidity	RHs	0		95	%	
Operating Humidity	RHo	0		85	%	
Data Rate	BRate	0.1		400	Gbps	
Durability Cycles			2000	2250	Cycles	

# **High Speed Characteristics**

Parameter	Symbol	Min.	Тур.	Max.	Unit	Notes
Input/Output Impedance	Zd	90	100	110	Ohm	1
Return Loss	SDD11/22	IEEE 802.3bj CL92.10.3.			dB	2
Insertion Loss	SDD21	0.845		6.615	dB	3
Insertion Loss Deviation	ILD	-1		1		2
Skew Between Lanes	SKEW			200	ps	

# Notes:

- 1. Differential impedance.
- 2. At Nyquist Frequency
- 3. Exclude the MCB insertion loss, at 13GHz.

# **Pin Descriptions**

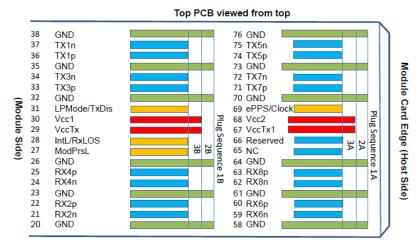
Pin	Logic	Symbol	Name/Description	Notes
1		GND	Module Ground (Logic and Power Return Path).	1
2	CML-I	Tx2-	Transmit Differential Pairs from Host to Module.	
3	CML-I	Tx2+	Transmit Differential Pairs from Host to Module.	
4		GND	Module Ground (Logic and Power Return Path).	1
5	CML-I	Tx4-	Transmit Differential Pairs from Host to Module.	
6	CML-I	Tx4+	Transmit Differential Pairs from Host to Module.	
7		GND	Module Ground (Logic and Power Return Path).	1
8	LVTTL-I	ModSelL	Module Select.	
9	LVTTL-I	ResetL	Module Reset.	
10		VccRx	+3.3V Receiver Power Supply.	2
11	LVCMOS-I/O	SCL	2-Wire Serial Interface Clock.	3
12	LVCMOS-I/O	SDA	2-Wire Serial Interface Data.	3
13		GND	Module Ground (Logic and Power Return Path).	1
14	CML-O	Rx3+	Receive Differential Pairs from Module to Host.	
15	CML-O	Rx3-	Receive Differential Pairs from Module to Host.	
16		GND	Module Ground (Logic and Power Return Path).	1
17	CML-O	Rx1+	Receive Differential Pairs from Module to Host.	
18	CML-O	Rx1-	Receive Differential Pairs from Module to Host.	
19		GND	Module Ground (Logic and Power Return Path).	1
20		GND	Module Ground (Logic and Power Return Path).	1
21	CML-O	Rx2-	Receive Differential Pairs from Module to Host.	
22	CML-O	Rx2+	Receive Differential Pairs from Module to Host.	
23		GND	Module Ground (Logic and Power Return Path).	1
24	CML-O	Rx4-	Receive Differential Pairs from Module to Host.	
25	CML-O	Rx4+	Receive Differential Pairs from Module to Host.	
26		GND	Module Ground (Logic and Power Return Path).	1
27	LVTTL-O	ModPrsL	Module Present.	4
28		IntL	Interrupt.	5
29		VccTx	+3.3V Transmitter Power Supply.	2
30		Vcc1	+3.3V Power Supply.	2
31	LVTTL-I	LPMode	Low-Power Mode.	
32		GND	Module Ground (Logic and Power Return Path).	1
33	CML-I	Tx3+	Transmit Differential Pairs from Host to Module.	
34	CML-I	Tx3-	Transmit Differential Pairs from Host to Module.	
35		GND	Module Ground (Logic and Power Return Path).	1
36	CML-I	Tx1+	Transmit Differential Pairs from Host to Module.	
37	CML-I	Tx1-	Transmit Differential Pairs from Host to Module.	

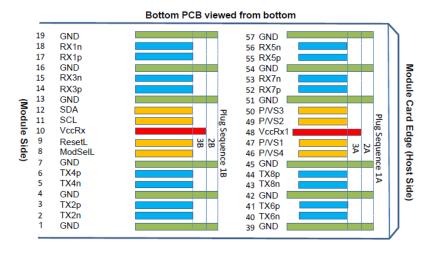
38		GND	Module Ground (Logic and Power Return Path).	1
39		GND	Module Ground (Logic and Power Return Path).	1
40	CML-I	Tx6-	Transmit Differential Pairs from Host to Module.	
41	CML-I	Tx6+	Transmit Differential Pairs from Host to Module.	
42		GND	Module Ground (Logic and Power Return Path).	1
43	CML-I	Tx8-	Transmit Differential Pairs from Host to Module.	
44	CML-I	Tx8+	Transmit Differential Pairs from Host to Module.	
45		GND	Module Ground (Logic and Power Return Path).	1
46		Reserved	For Future Use. Not Connected.	6
47	LVCMOS-O	VS1	Module Vendor-Specific 1.	6
48		VccRx1	+3.3V Receiver Power Supply.	2
49	LVCMOS-I	VS2	Module Vendor-Specific 2.	6
50	LVCMOS-I/O	VS3	Module Vendor-Specific 3.	6
51		GND	Module Ground (Logic and Power Return Path).	1
52	CML-O	Rx7+	Receive Differential Pairs from Module to Host.	
53	CML-O	Rx7-	Receive Differential Pairs from Module to Host.	
54		GND	Module Ground (Logic and Power Return Path).	1
55	CML-O	Rx5+	Receive Differential Pairs from Module to Host.	
56	CML-O	Rx5-	Receive Differential Pairs from Module to Host.	
57		GND	Module Ground (Logic and Power Return Path).	1
58		GND	Module Ground (Logic and Power Return Path).	1
59	CML-O	Rx6-	Receive Differential Pairs from Module to Host.	
60	CML-O	Rx6+	Receive Differential Pairs from Module to Host.	
61		GND	Module Ground (Logic and Power Return Path).	1
62	CML-O	Rx8-	Receive Differential Pairs from Module to Host.	
63	CML-O	Rx8+	Receive Differential Pairs from Module to Host.	
64		GND	Module Ground (Logic and Power Return Path).	1
65		NC	Not Connected.	6
66		Reserved	For Future Use. Not Connected.	6
67		VccTx1	+3.3V Transmitter Power Supply.	2
68		Vcc2	+3.3V Power Supply.	2
69	LVTTL-I	ePPS	Precision Time Protocol (PTP) Reference Clock Input.	
70		GND	Module Ground (Logic and Power Return Path).	1
71	CML-I	Tx7+	Transmit Differential Pairs from Host to Module.	
72	CML-I	Tx7-	Transmit Differential Pairs from Host to Module.	
73		GND	Module Ground (Logic and Power Return Path).	1
74	CML-I	Tx5+	Transmit Differential Pairs from Host to Module.	
75	CML-I	Тх5-	Transmit Differential Pairs from Host to Module.	
76		GND	Module Ground (Logic and Power Return Path).	1

## Notes:

- 1. QSFP-DD uses common ground (GND) for all signals and supply (power). All are common with the QSFP-DD module, and all module voltages are referenced to this potential unless otherwise noted. Connect these directly to the host board signal common ground plane.
- 2. VccRx, VccRx1, Vcc1, Vcc2, VccTx, and VccTx1 shall be applied concurrently. VccRx, VccRx1, Vcc1, Vcc2, VccTx, and VccTx1 are internally connected within the module. The connector Vcc pins are each rated for a maximum current of 1.0A.
- 3. Open drain. Requires 1.0k to 3.3k pull-up resistor to 3.3V on the host.
- 4. Indication from module to host. Requires 4.7k to 10k pull-up resistor to 3.3V on the host.
- 5. Open collector. Interrupt request from module to host. Requires 4.7k pull-up resistor to 3.3V on the host.
- 6. Reserved and NC pins may be terminated with  $50\Omega$  to ground on the host. Vendor-Specific and Reserved pads shall have an impedance to the GND that is greater than  $10k\Omega$  and is less than 100pF.

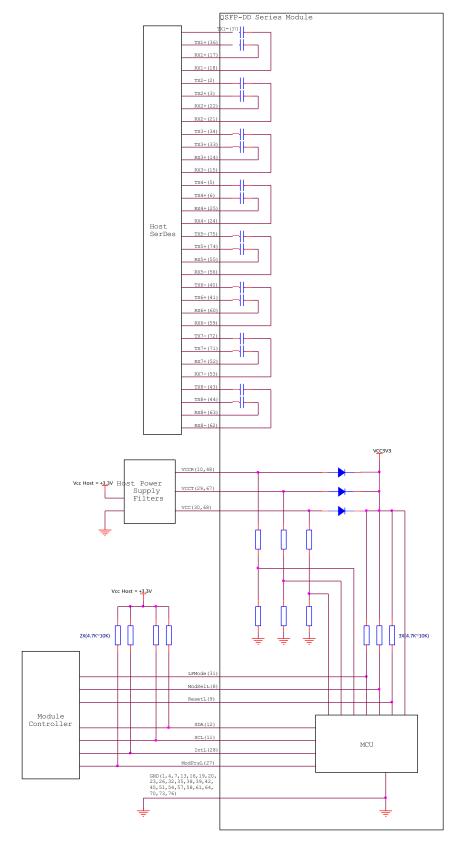
## **Electrical Pad Layout**





Pin-Out of Connector Block on the Host Board

# **Typical Application Circuit**



## **Status LED**

A multi-color LED must be viewed from the front of the module in order to signify high/low power modes, as well as interrupts:

Solid green: low-power mode

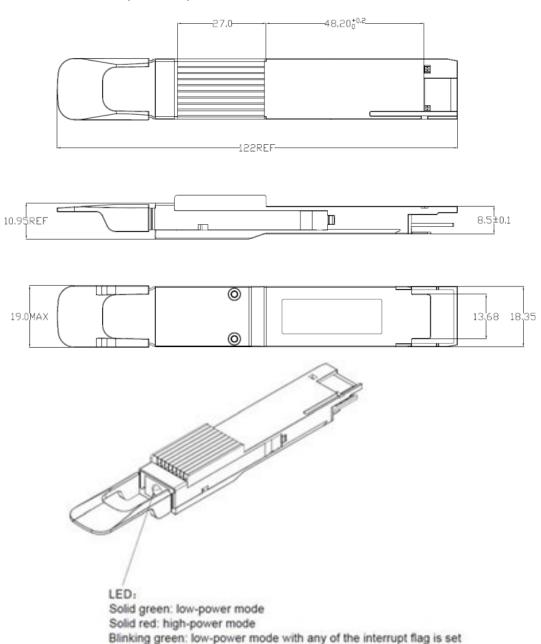
• Solid red: high-power mode

Blinking green: low-power mode with any of the interrupt flag is set

• Blinking red: high-power mode with any of the interrupt flag is set

# **Mechanical Specifications**

Dimensions are in millimeters. (Unit: mm)



Blinking red: high-power mode with any of the interrupt flag is set

# **About Skylane Optics**

Skylane is a leading provider of transceivers for optical communication.

We offer an extensive portfolio for the enterprise, access, datacenter and metropolitan fiber optical market as well as for smart home applications and home networks.

We cover the European, South American and North American market with a strong partner network and have offices in Belgium, Brazil, Sweden and USA.

Our offerings are characterized by high quality and performance. In combination with our strong technical support, we enable our customers to build cost optimized network solutions.

We offer an extensive range of high-quality products including transceivers (Optical and copper), Active Optical Cable (AOC), Direct Attach Cable (DAC), Mux/Demux, Coding Box (SKYGATE).











